

## DEX-011 X 75

Solvent Epoxy Resin

### Product data

#### Description

DEX-011 x 75 is a mixed solution obtained by dissolving solid epoxy resins having high viscosity and low molecular weight in xylene.

#### Packing

- DEX-011 x 75 is packed and delivered in steel drums, 220 kg per drum as a standard pack. Other packs are available on request.

### Technical Properties

Property	Unit	Value	Test Method
Epoxy equivalent weight	G/EQ	450-500	ASTM D1652
Viscosity at 25°C	M PA.S	8000-12000	ASTM D445
Color	PT/CO SCALE ≤	100	ASTM D1209
Non volatile	WT. %	74-76	ISO 3251
Density at 25°C	KG/L	01.09	---
Flash point (PMCC)	°C	24	ASTM D93

### Applications

With advantages like good adhesion, good resistance to acid, alkali, salt, weather, and so on, the products can be widely used in coatings, electrical, construction and other related fields, recognised for the good performances, these series are designed to make heat conduction plates, aluminum substrate and so on.

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China  
Jiangsu, Changzhou  
Tel +86 0512 63659101  
[sales@dexresin.com](mailto:sales@dexresin.com)  
[info@dexresin.com](mailto:info@dexresin.com)

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